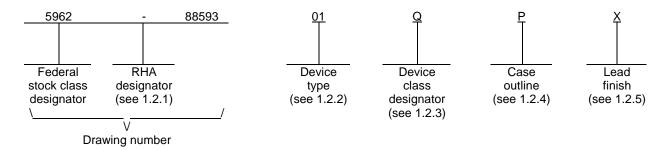
								F	REVISION	SNC									
LTR					[DESCR	IPTIO	١					DA	TE (YF	R-MO-D	A)		APPR	OVED
Α	Chang	e to or	ne part-	-one pa	art nun	nber for	mat. A	dded t	able III.					91-12	-11		M.	A. FRY	Έ
В	Chang	es in a	accorda	ance w	ith NO	R 5962	-R036-	97.						96-11	-26		R.	MONN	IN
С	Chang Update	e slew e boile	rate varplate.	alue in Redra	table I ıwnr	. Remo	ove tab	le III, fi	gures 2	2, 3, 4, 8	and 5.			00-10	-18		R.	MONN	IN
D	Replac	ed ref	erence	to MIL	-STD-	973 wit	h refer	ence to	MIL-P	RF-385	35rr	р		03-05	-01		R	. MONN	IIN
E ORIGINA	L FIRST S	SHEET	OF TH	HIS DR	AWIN	G HAS	BEEN	REPLÆ	ACED.										
	L FIRST S	SHEET	· OF Th	HIS DR	AWIN	G HAS	BEEN	REPLA	ACED.										
E ORIGINA V EET	L FIRST S	SHEET	· OF Th	HIS DR	:AWIN	G HAS	BEEN	REPLA	ACED.										

OF SHEETS SHEET 5 | 6 | 7 | 8 | 9 | 10 | PMIC N/A PREPARED BY **GARY ZAHN DEFENSE SUPPLY CENTER COLUMBUS STANDARD** COLUMBUS, OHIO 43216 **CHECKED BY RAY MONNIN MICROCIRCUIT** http://www.dscc.dla.mil **DRAWING** APPROVED BY D. A. DICENZO THIS DRAWING IS AVAILABLE MICROCIRCUIT, LINEAR, LOW OFFSET, LOW FOR USE BY ALL POWER DUAL OPERATIONAL AMPLIFIER, **DEPARTMENTS** MONOLITHIC SILICON AND AGENCIES OF THE DRAWING APPROVAL DATE DEPARTMENT OF DEFENSE 88-07-25 AMSC N/A **REVISION LEVEL** SIZE CAGE CODE 5962-88593 67268 D Α SHEET 1 OF 10

DSCC FORM 2233 APR 97

1. SCOPE

- 1.1 <u>Scope</u>. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.
 - 1.2 PIN. The PIN is as shown in the following example:



- 1.2.1 <u>RHA designator</u>. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
 - 1.2.2 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows:

Device type	Generic number	<u>Circuit function</u>
01	OP200A	Dual, low offset, low power operational amplifier

1.2.3 <u>Device class designator</u>. The device class designator is a single letter identifying the product assurance level as follows:

<u>Device class</u> <u>Device requirements documentation</u>

M Vendor self-certification to the requirements for MIL-STD-883 compliant, non-

JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A

Q or V Certification and qualification to MIL-PRF-38535

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
Р	GDIP1-T8 or CDIP2-T8	8	Dual-in-line
2	CQCC1-N20	20	Square chip carrier

1.2.5 <u>Lead finish</u>. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

STANDARD
MICROCIRCUIT DRAWING

DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000

SIZE A		5962-88593
	REVISION LEVEL D	SHEET 2

1.3 Absolute maximum ratings. 1/

Supply voltage range	±20 V dc
Input voltage	
Output short-circuit duration	Indefinite
Differential input voltage	±30 V dc
Storage temperature range	-65°C to +150°C
Lead temperature range (soldering, 60 seconds)	
Junction temperature (T _J)	+150°C
Thermal resistance, junction-to-case (θ_{JC})	See MIL-STD-1835
Thermal resistance (θ_{JA}):	
Case P	119°C/W
Cace 2	120°C/M

1.4 Recommended operating conditions.

Supply voltage (V _{CC})	±15 V dc
Source resistance from ground to input terminals (R _s)	50 Ω
Ambient operating temperature range (T _A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings. MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization

Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL D	SHEET 3

3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.
 - 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.
 - 3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.
- 3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.
- 3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.
- 3.5.1 <u>Certification/compliance mark</u>. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.
- 3.6 <u>Certificate of compliance</u>. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change for device class M.</u> For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-PRF-38535, appendix A.
- 3.9 <u>Verification and review for device class M</u>. For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device class M.</u> Device class M devices covered by this drawing shall be in microcircuit group number 49 (see MIL-PRF-38535, appendix A).

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 4

D

TABLE I. <u>Electrical performance characteristics</u>.

Test	Symbol	$ \begin{array}{c} \text{Conditions} \\ -55^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C} \\ \text{V}_{\text{CC}} = \pm 15 \text{ V}, \text{R}_{\text{S}} = 50 \Omega \\ \text{unless otherwise specified} \end{array} $	Group A subgroups	Device type	Li	mits	Unit
					Min	Max	
Input offset voltage	V _{IO}		1	01	-75	+75	μV
			2, 3		-125	+125	
Input offset current	I _{IO}	V _{CM} = 0 V	1	01	-1.0	+1.0	nA
			2, 3	_	-2.5	+2.5	
Input bias current	±I _{IB}	V _{CM} = 0 V	1	01	-2.0	+2.0	nA
			2, 3		-5.0	+5.0	
Common mode rejection ratio <u>1</u> /	CMRR	$V_{CM} = I_{VR} = \pm 11 \text{ V}$	1	01	120		dB
			2, 3	_	115		-
Power supply rejection ratio	PSRR	$V_{CC} = \pm 3 \text{ V to } \pm 18 \text{ V}$	1	01		1.8	μV/V
			2, 3	_		3.2	=
Supply current no load 2/	I _{SY}		1	01		1.45	mA
			2, 3			1.55	
Large signal voltage gain	A _{VS}	$V_{OUT} = \pm 10 \text{ V}, R_L = 2 \text{ k}\Omega$	4	01	2000		V/mV
			5, 6		1000		1
		$V_{OUT} = \pm 10 \text{ V}, R_L = 10 \text{ k}\Omega$	4		5000		1
			5, 6		3000		
Output voltage swing	+V _{OP}	$R_L = 2 \text{ k}\Omega$	4, 5, 6	01	+11		V
		$R_L = 10 \text{ k}\Omega$	1		+12		
	-V _{OP}	$R_L = 2 k\Omega$	4, 5, 6			-11	1
		$R_L = 10 \text{ k}\Omega$	1			-12	1
Input noise voltage	En	$f_O = 1 \text{ Hz to } 100 \text{ Hz},$ $T_A = +25^{\circ}\text{C}$	7	01		250	nV _{rms}
Slew rate	SR	$T_A = +25^{\circ}C$ $T_A = +25^{\circ}C, A_V = +1$	7	01	0.05		V/µs
Input offset voltage temperature coefficient	TC _{VIO}	T _A = +125°C, -55°C	8	01		0.5	μV/°C

 $[\]underline{1}/\ I_{VR}$ is defined as the V_{CM} range used for the CMRR test. $\underline{2}/\ I_{SY}$ limit = total of all two amplifiers.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL D	SHEET 5

Device type	01		
Case outlines	Р	2	
Terminal number	Termina	al symbol	
1	OUT A	NC	
2	-IN A	OUT A	
3	+IN A	NC	
4	-V _{CC}	NC	
5	+IN B	-IN A	
6	-IN B	NC	
7	OUT B	+IN A	
8	+V _{CC}	NC	
9		NC	
10		-V _{CC}	
11		NC	
12		+IN B	
13		NC	
14		NC	
15		-IN B	
16		NC	
17		OUT B	
18		NC	
19		NC	
20		+V _{CC}	

NC = No connection

FIGURE 1. <u>Terminal connections</u>.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL D	SHEET 6

4. QUALITY ASSURANCE PROVISIONS

- 4.1 <u>Sampling and inspection</u>. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
 - (2) $T_A = +125^{\circ}C$, minimum.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.

4.2.2 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.
- c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.
- 4.3 <u>Qualification inspection for device classes Q and V.</u> Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).
- 4.4 <u>Conformance inspection</u>. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection.

- a. Tests shall be as specified in table IIA herein.
- b. For device class M, Q, and V, subgroups 7 and 8 shall include verifying the functionality of the device.
- c. Subgroups 9, 10, and 11 of table I of method 5005 of MIL-STD-883 shall be omitted.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL D	SHEET 7

TABLE IIA. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device	Device	Device
	class M	class Q	class V
Interim electrical	1	1	1
parameters (see 4.2)			
Final electrical	1,2,3,4,5,6 <u>1</u> /	1,2,3,4,5,6 <u>1</u> /	1,2,3,4, <u>1</u> / <u>2</u> /
parameters (see 4.2)			5,6
Group A test	1,2,3,4,5,6,7,8	1,2,3,4,5,6,7,8	1,2,3,4,5,6,7,8
requirements (see 4.4)			
Group C end-point electrical	1	1	1 <u>2</u> /
parameters (see 4.4)			
Group D end-point electrical	1	1	1
parameters (see 4.4)			
Group E end-point electrical			
parameters (see 4.4)			

^{1/} PDA applies to subgroup 1.

Table IIB. 240 hour burn-in and group C end-point electrical parameters.

Test	Limit		Delta		
	Min	Max	Min	Max	Units
V _{IO}	-75	75	-50	50	μV
±I _{IB}	-2	2	-1.5	1.5	nA

- 4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - b. $T_A = +125$ °C, minimum.
 - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-88593
		REVISION LEVEL D	SHEET 8

^{2/} See table IIB for delta measurement parameters.

- 4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - 4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.4 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).
 - a. End-point electrical parameters shall be as specified in table IIA herein.
 - b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, after exposure, to the subgroups specified in table IIA herein.
 - c. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

5. PACKAGING

- 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.
 - 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.
 - 6.1.2 <u>Substitutability</u>. Device class Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.
- 6.3 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.
- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0547.
- 6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.
 - 6.6 Sources of supply.
- 6.6.1 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.
- 6.6.2 <u>Approved sources of supply for device class M.</u> Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

STANDARD MICROCIRCUIT DRAWING	SIZE A		5962-88593
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL D	SHEET 9

APPENDIX

SUBSTITUTION DATA

10. SCOPE

10.1 <u>Scope</u>. This appendix contains the PIN substitution information to support the one part-one part number system. For new designs, after the date of this document the new PIN shall be used in lieu of the old PIN. For existing designs prior to the date of this document the new PIN can be used in lieu of the old PIN. The appendix is a mandatory part of the specification. The information herein is intended for compliance. The PIN substitution data shall be as follows:

20. APPLICABLE DOCUMENTS

This section is not applicable to this appendix.

30. SUBSTITUTION DATA

NEW PIN OLD PIN

5962-8859301MPX 5962-8859301PX

5962-8859301M2X 5962-88593012X

STANDARD		
MICROCIRCUIT DRAWING		

DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000

SIZE A		5962-88593
	REVISION LEVEL D	SHEET 10

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 03-05-01

Approved sources of supply for SMD 5962-88593 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard	Vendor	Vendor
microcircuit drawing	CAGE	similar
PIN <u>1</u> /	number	PIN <u>2</u> /
5962-8859301MPA	24355	OP-200AZ/883
5962-8859301M2A	24355	OP-200ARC/883
5962-8859301VPA	24355	OP200AZ/QMLV
5962-8859301V2A	24355	OP200ARC/QMLV

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

24355

Vendor name and address

Analog Devices RT 1 Industrial Park PO Box 9106 Norwood, MA 02062 Point of contact: 150

1500 Space Park Drive PO Box 58020 Santa Clara, CA 95052-8020

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.